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Electronic Patent Application Submission
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EFS ID: 64376
Application ID: 10823840
Title of Invention: ELECTRICAL BIAS DURING WAFER
EXIT FROM ELECTROLYTE BATH
First Named Inventor: DMITRY LUBOMIRSKY
Domestic/Foreign Application: Domestic Application
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**TRANSMITTAL**

Electronic Version v1.1

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Title of Invention	ELECTRICAL BIAS DURING WAFER EXIT FROM ELECTROLYTE BATH									
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Mr. N. ALEXANDER NOLTE Registered Number: 45689</td><td>[N. ALEXANDER NOLTE]</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Mr. N. ALEXANDER NOLTE Registered Number: 45689	[N. ALEXANDER NOLTE]	Attorney		
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<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>AMAT8389NAN3-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	AMAT8389NAN3-usidst.xml		us-ids.dtd		us-ids.xsl
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Comments NO FEE DUE - FILED BEFORE 1ST OA - 3 OF 3										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

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	16	6551488	2003-04-22	HEY, ET AL.
	17	6557237	2003-05-06	OLGADO
	18	6565729	2003-05-20	CHEN, ET AL.
	19	6571657	2003-06-03	OLGADO, ET AL.
	20	6582578	2003-06-24	DORDI, ET AL.
	21	6585876	2003-07-01	DORDI, ET AL.
	22	6613214	2003-09-02	DORDI, ET AL.
	23	6632345	2003-10-14	CHEN
	24	6662673	2003-12-16	OLGADO

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
	1	20010015321	2001-08-23	REID, ET AL.			
	2	20020000380	2002-01-03	GRAHAM, ET AL.			

Remarks

Note: Remarks are not for responding to an office action.

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Signature

Examiner Name	Date